N-CHANNEL MOS FIELD EFFECT POWER TRANSISTOR

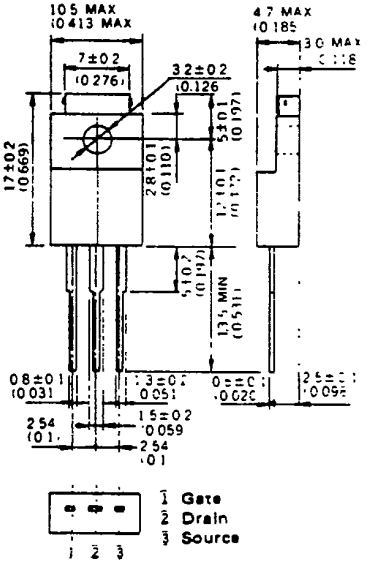
2SK736

DESCRIPTION The 2SK736 is N-Channel MOS Field Effect Power Transistor designed for solenoid, motor and lamp driver.

FEATURES

- Gate Drive – Logic level –
- Low $R_{DS(on)}$
- No Secondary Breakdown

PACKAGE DIMENSIONS
in millimeters (inches)



ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures

Storage Temperature	−55 to +150	°C
Channel Temperature	150 Maximum	°C

Maximum Power Dissipations

Total Power Dissipation (T_a = 25 °C)	2.0	W
Total Power Dissipation (T_c = 25 °C)	35	W

Maximum Voltages and Currents (T_a = 25 °C)

V_{DSS}	Drain to Source Voltage	100	V
V_{GSS}	Gate to Source Voltage	±20	V
$I_{D(DC)}$	Drain Current (DC)	±15	A
$I_{D(pulse)}$	Drain Current (pulse)*	±60	A

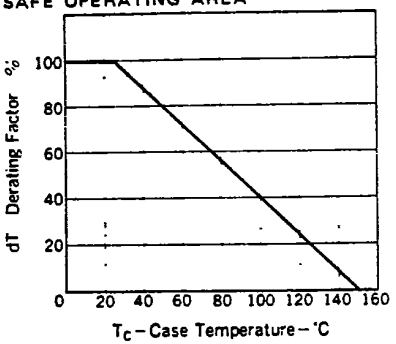
*PW ≦ 300 μs, Duty Cycle ≦ 10 %

ELECTRICAL CHARACTERISTICS (T_a = 25 °C)

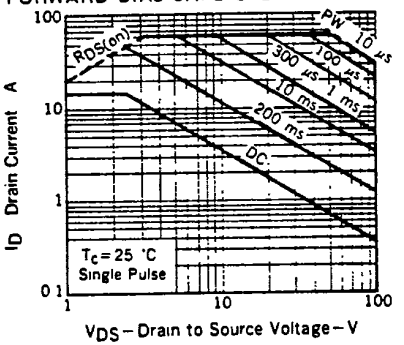
SYMBOL	CHARACTERISTIC	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
$R_{DS(on)}$	Drain to Source On-State Resistance			0.08	Ω	V_{GS} = 10 V, I_D = 6 A
$R_{DS(on)}$	Drain to Source On-State Resistance			0.10	Ω	V_{GS} = 4 V, I_D = 6 A
$V_{GS(off)}$	Gate to Source Cutoff Voltage	1.0		2.5	V	V_{DS} = 10 V, I_D = 1 mA
$\|y_{fs}\|$	Forward Transfer Admittance	5.0			S	V_{DS} = 10 V, I_D = 6 A
I_{DSS}	Drain Leakage Current			10	μA	V_{DS} = 100 V, V_{GS} = 0
I_{GSS}	Gate to Source Leakage Current			±100	nA	V_{GS} = ±20 V, V_{DS} = 0
C_{iss}	Input Capacitance		2400		pF	V_{DS} = 10 V V_{GS} = 0 f = 1 MHz
C_{oss}	Output Capacitance		600		pF	
C_{rss}	Reverse Transfer Capacitance		100		pF	
$t_{d(on)}$	Turn On Delay Time		15		ns	I_D = 6 A, V_{CC} ≒ 50 V R_L = 5 Ω R_{in} = 10 Ω
t_r	Rise Time		70		ns	
$t_{d(off)}$	Turn Off Delay Time		250		ns	
t_f	Fall Time		160		ns	

TYPICAL CHARACTERISTICS (T_a = 25 °C)

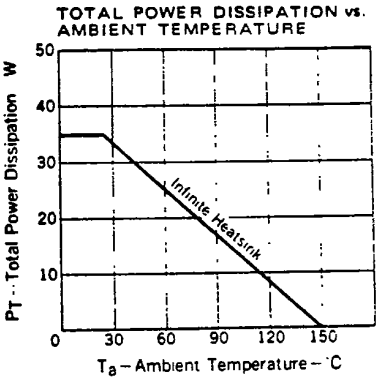
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



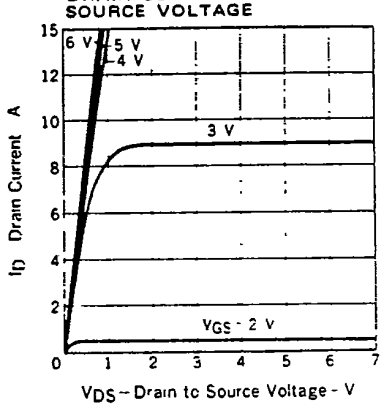
FORWARD BIAS SAFE OPERATING AREA



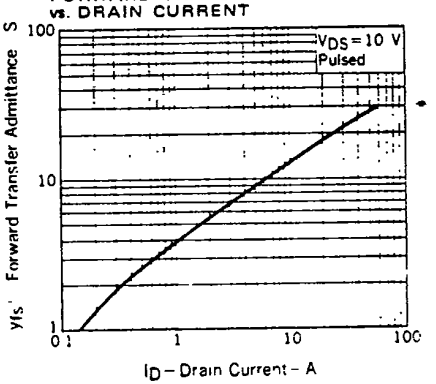
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



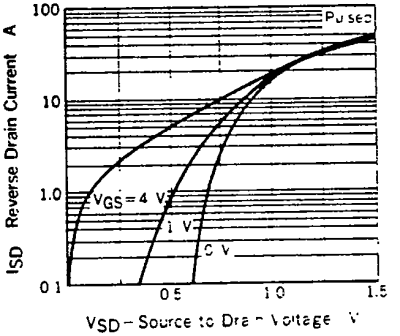
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



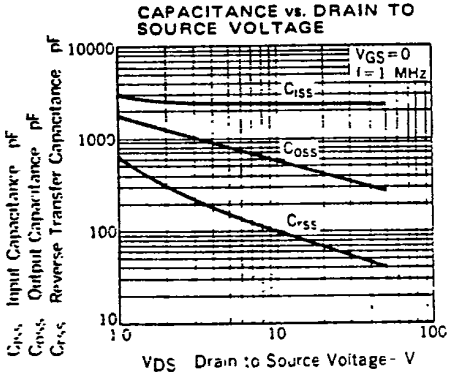
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



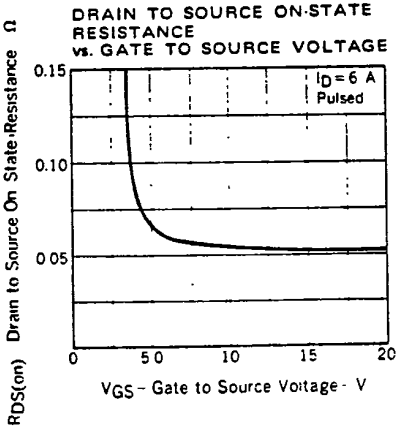
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



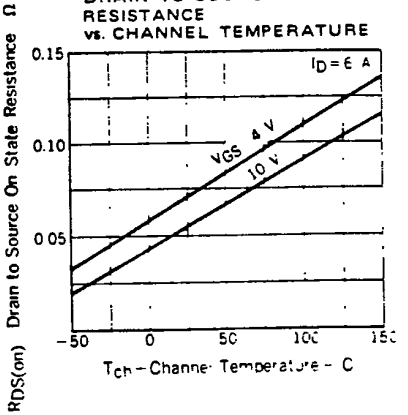
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



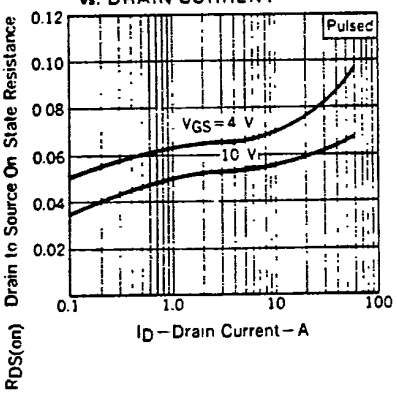
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



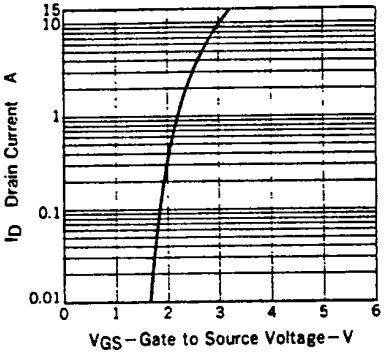
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



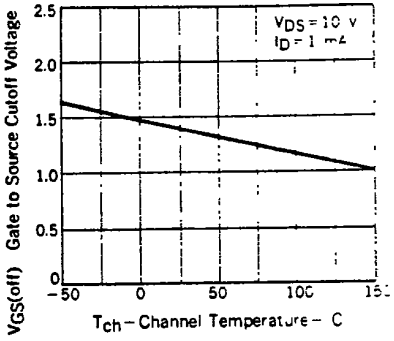
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



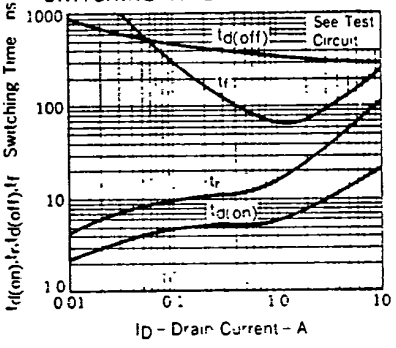
TRANSFER CHARACTERISTIC



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



SWITCHING TIME vs. DRAIN CURRENT



SWITCHING TIME TEST CIRCUIT